

650V N-Channel MOSFET

FEATURES

- I Fast switching
- I 100% avalanche tested
- I Improved dv/dt capability

APPLICATIONS

- I Switch Mode Power Supply (SMPS)
- I Uninterruptible Power Supply (UPS)
- I Power Factor Correction (PFC)



Device Marking and Package Information

Device	Package	Marking
MPF7N65	TO-220F	MPF7N65
MP7N65	TO-220	MP7N65
MDP7N65	TO-251	MDP7N65
MDT7N65	TO-252	MDT7N65

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value				Unit
		TO-220F	TO-220	TO-251	TO-252	
Drain-Source Voltage ($V_{GS} = 0V$)	V_{DSS}	650				V
Continuous Drain Current	I_D	7				A
Pulsed Drain Current (note1)	I_{DM}	28				A
Gate-Source Voltage	V_{GSS}	± 30				V
Single Pulse Avalanche Energy (note2)	E_{AS}	165				mJ
Avalanche Current (note1)	I_{AS}	5.76				A
Repetitive Avalanche Energy (note1)	E_{AR}	100				mJ
Power Dissipation ($T_C = 25^\circ\text{C}$)	P_D	63	97			W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150				$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value				Unit
		TO-220F	TO-220	TO-251	TO-252	
Thermal Resistance, Junction-to-Case	R_{thJC}	1.98	1.29			K/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	60			

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	650	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^\circ\text{C}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 30V$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	3.0	--	4.0	V
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 3.5A$	--	1.1	1.35	Ω
Dynamic						
Input Capacitance	C_{iss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$ $f = 1.0\text{MHz}$	--	891	--	pF
Output Capacitance	C_{oss}		--	87	--	
Reverse Transfer Capacitance	C_{riss}		--	10	--	
Total Gate Charge	Q_g	$V_{DD} = 520V, I_D = 7A,$ $V_{GS} = 10V$	--	32	--	nC
Gate-Source Charge	Q_{gs}		--	4.6	--	
Gate-Drain Charge	Q_{gd}		--	14	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 325V, I_D = 7A,$ $R_G = 25\Omega$	--	39	--	ns
Turn-on Rise Time	t_r		--	23	--	
Turn-off Delay Time	$t_{d(off)}$		--	137	--	
Turn-off Fall Time	t_f		--	60	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	7.0	A
Pulsed Diode Forward Current	I_{SM}		--	--	28	
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{SD} = 3.5A, V_{GS} = 0V$	--	--	1.4	V
Reverse Recovery Time	t_{rr}	$V_{GS} = 0V, I_S = 7A,$ $di_F/dt = 100A/\mu\text{s}$	--	575	--	ns
Reverse Recovery Charge	Q_{rr}		--	1.9	--	μC

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $L=10\text{mH}, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 1\%$

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^\circ\text{C}$)

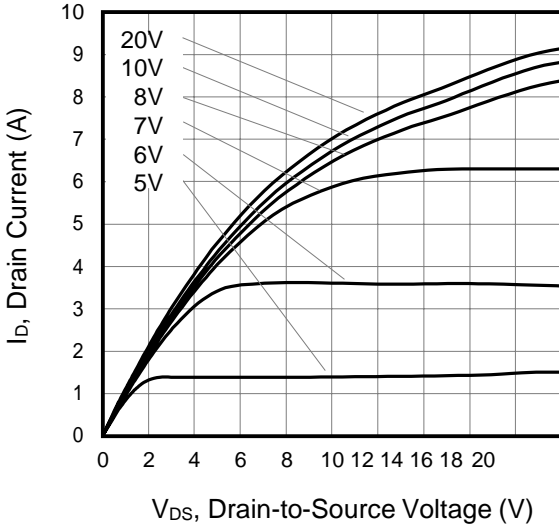


Figure 2. Body Diode Forward Voltage

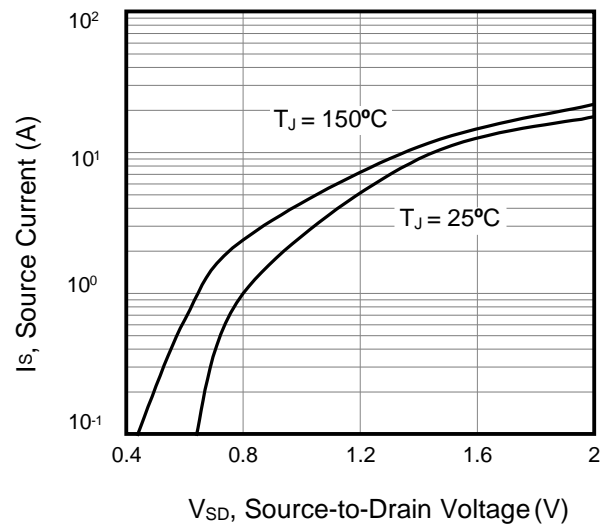


Figure 3. Drain Current vs. Temperature

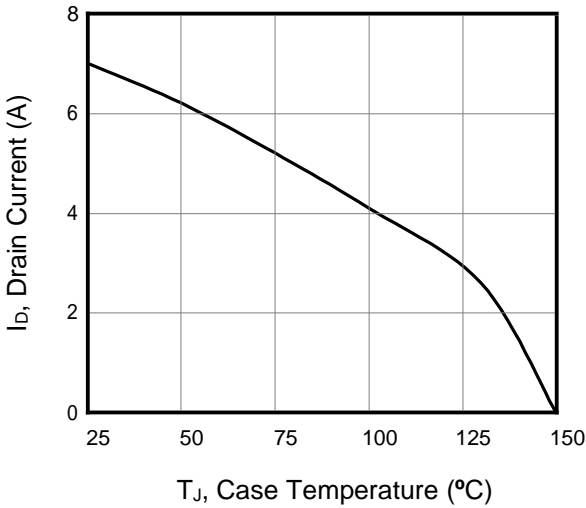


Figure 4. BV_{DSS} Variation vs. Temperature

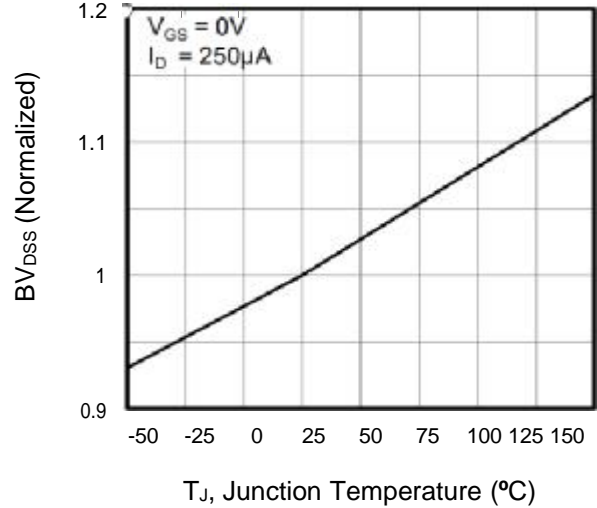


Figure 5. Transfer Characteristics

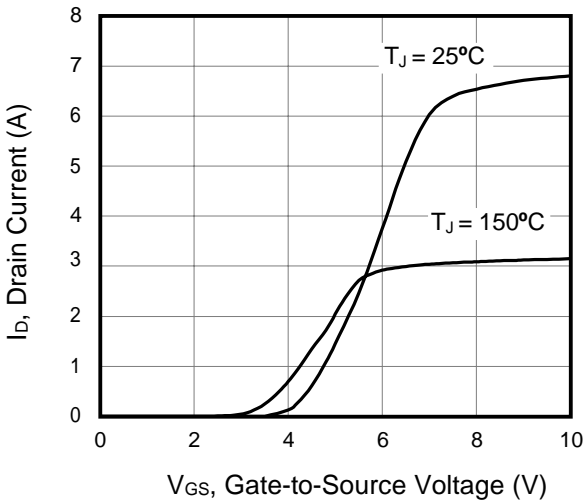
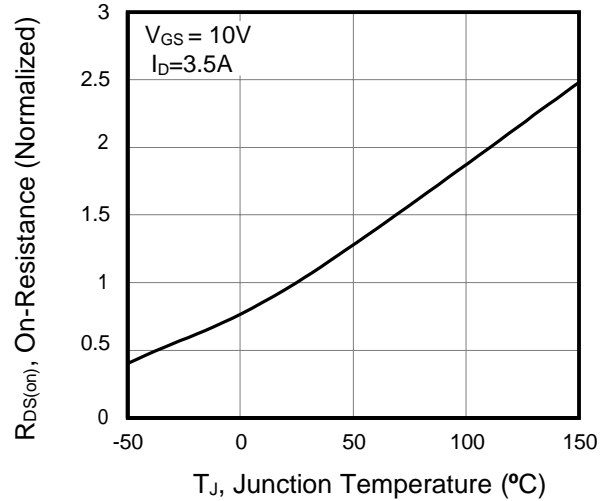


Figure 6. On-Resistance vs. Temperature



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Capacitance

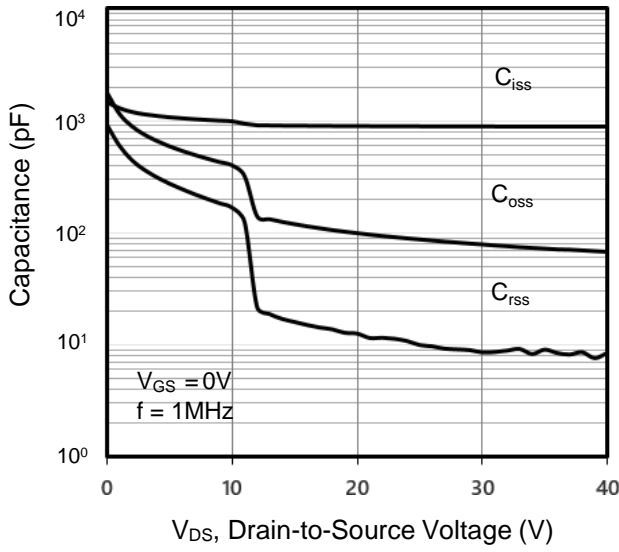


Figure 8. Gate Charge

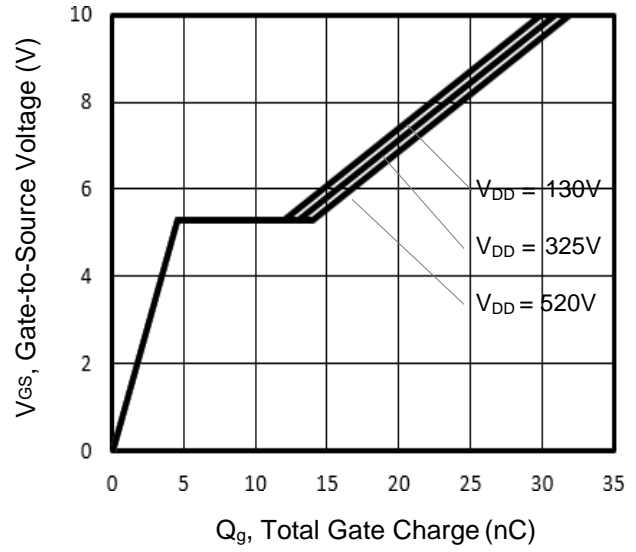


Figure 9. Transient Thermal Impedance
TO-220, TO-251, TO-252

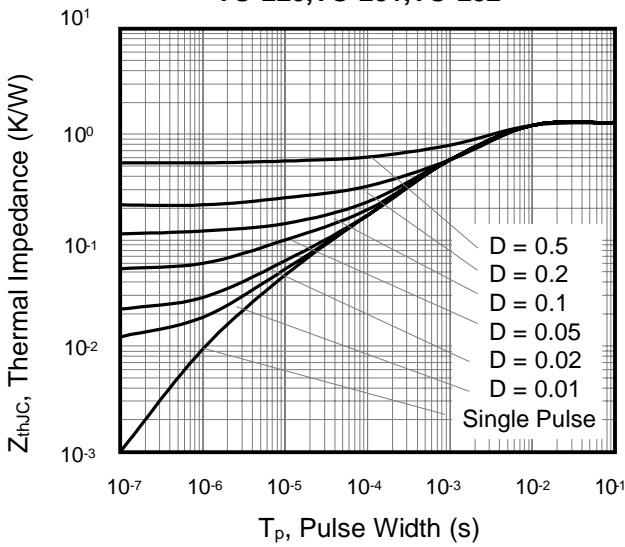


Figure 10. Transient Thermal Impedance
TO-220F

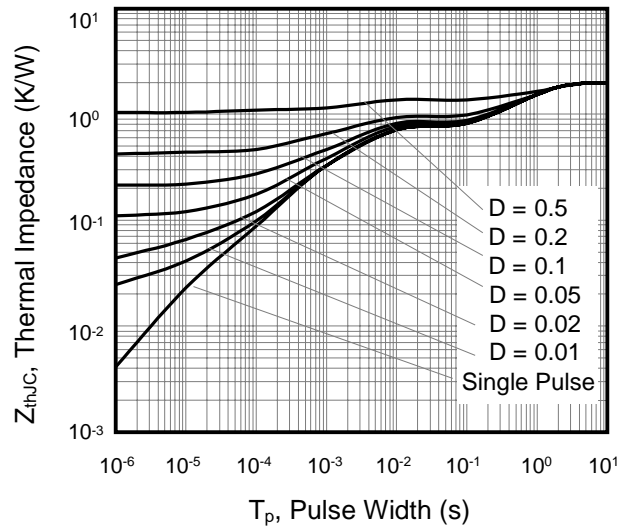


Figure A: Gate Charge Test Circuit and Waveform

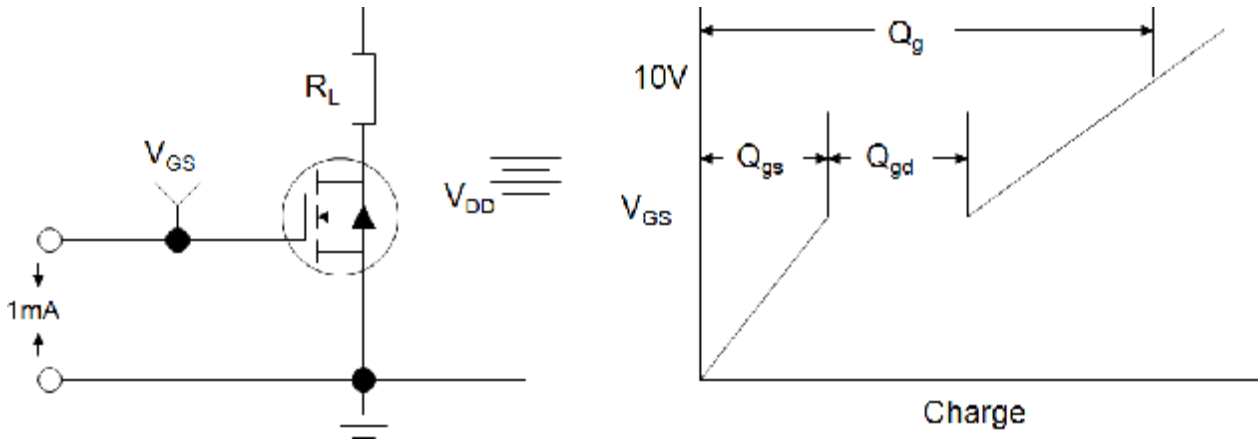


Figure B: Resistive Switching Test Circuit and Waveform

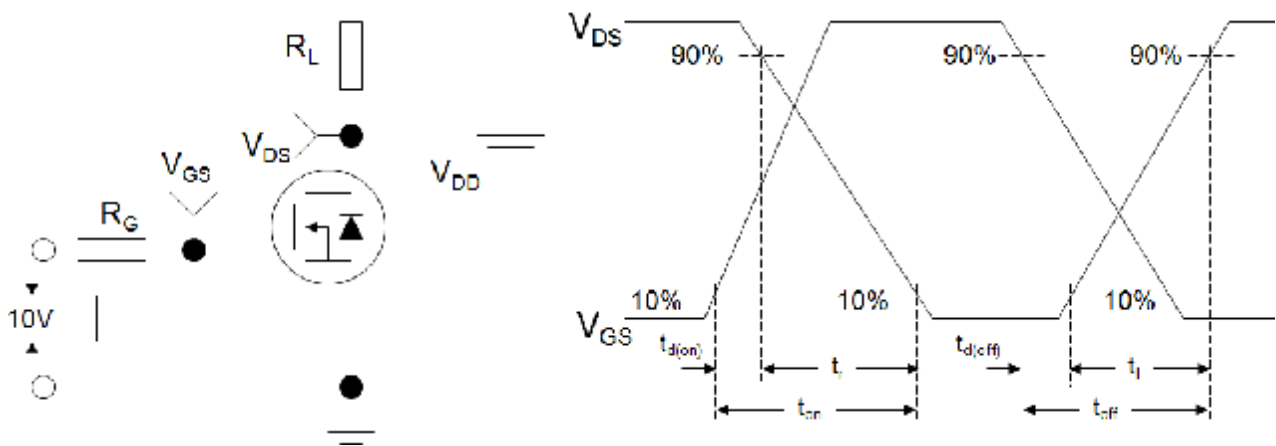


Figure C: Unclamped Inductive Switching Test Circuit and Waveform

